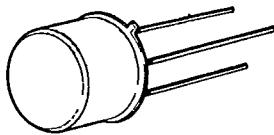
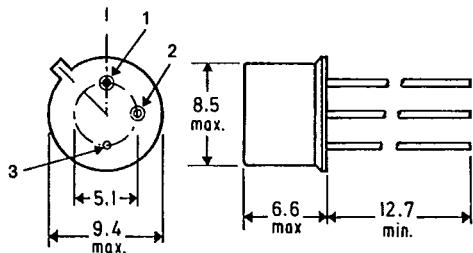


JAN 05 1988 SMLB

T-39-09

SEMELAB**2N 6791****2N 6792****MECHANICAL DATA**

Dimensions in mm

MOS POWER**N-Channel Enhancement Mode****APPLICATIONS**

- INVERTERS
- MOTOR CONTROLS
- CHOPPERS

PIN 1—Source PIN 2—Gate PIN 3 Drain and Case

TO 39

ABSOLUTE MAXIMUM RATINGS (T_{CASE} = 25°C unless otherwise specified)

Parameter	2N 6791	2N 6792
V _{DS}	Drain source voltage	350V
V _{DGR}	Drain gate voltage (R _{GS} = 1 MΩ)	350V
I _D @ T _c = 25°C	Continuous drain current	±2A
I _D @ T _c = 100°C	Continuous drain current	±1.25A
I _{DM}	Pulsed drain current (I _i)	±4A
V _{GS}	Gate-source voltage	±40V
P _D @ T _c = 25°C	Maximum power dissipation	20W
P _D @ T _c = 100°C	Maximum power dissipation	8W
Junction to case	Linear derating factor	0.12 W/°C
Junction to ambient	Linear derating factor	0.006 W/°C
T _J	Operating and	−55 to 150°C
T _{stg}	storage temperature range	
Lead temperature	(1/16" from case for 10 secs.)	300°C

(i) Pulse test: Pulse width ≤300μsec, duty cycle ≤2%

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2N 6791 2N 6792

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ELECTRICAL CHARACTERISTICS ($T_{CASE} = 25^\circ\text{C}$ unless otherwise specified)

STATIC

Parameter	Type	Min.	Typ.	Max.	Units	Test Conditions
V_{DSS} Drain-Source Breakdown Voltage	2N6791	350*			V	$V_{GS} = 0$ $I_D = 1.0 \text{ mA}$
	2N6792	400*			V	
$V_{GS(th)}$ Gate-Threshold Voltage	All	2.0*		4.0*	V	$V_{DS} = V_{GS}, I_D = 1.0 \text{ mA}$
I_{GSSF} Gate-Body Leakage Forward	All			100*	nA	$V_{GS} = 20V$
I_{GSSR} Gate-Body Leakage Reverse	All			-100*	nA	$V_{GS} = -20V$
I_{DSS} Zero Gate Voltage Drain Current	All			1.0*	mA	$V_{DS} = \text{Max. Rating}, V_{GS} = 0$
	All			4.0*	mA	$V_{DS} = \text{Max. Rating}, V_{GS} = 0$ $T_C = 125^\circ\text{C}$
$I_{D(on)}$ On-State Drain Current ¹	2N6791	1.25			A	$V_{DS} > 2V_{DS(\text{ON})}, V_{GS} = 10V$
	2N6792	1.25			A	$V_{DS} > 2V_{DS(\text{ON})}, V_{GS} = 10V$
$V_{DS(on)}$ Static Drain-Source On-State Voltage ¹	2A6791			3.8*	V	$V_{GS} = 10V, I_D = 2.0A$
	2N6792			3.8*	V	$V_{GS} = 10V, I_D = 2.0A$
$R_{DS(on)}$ Static Drain-Source On-State Resistance ¹	2N6791			1.8*	Ω	$V_{GS} = 10V, I_D = 1.25A$
	2N6792			1.8*	Ω	$V_{GS} = 10V, I_D = 1.25A$
$R_{DS(on)}$ Static Drain-Source On-State Resistance ¹	2N6791			4.0*	Ω	$V_{GS} = 0, I_D = 1.25A T_C = 125^\circ\text{C}$
	2N6792			4.0*	Ω	$V_{GS} = 0, I_D = 1.25A T_C = 125^\circ\text{C}$

DYNAMIC

g_{fs} Forward Transductance ¹	All	1.0*		3.0*	S (Ω)	$V_{DS} > 2V_{DS(\text{ON})}, I_D = 1.25A$
C_{iss} Input Capacitance	All	200*		600*	pF	
C_{oss} Output Capacitance	All	40*		200*	pF	
C_{rss} Reverse Transfer Capacitance	All	5*		40*	pF	$V_{GS} = 0, V_{DS} = 25V$ $f = 1 \text{ MHz}$
$t_{d(on)}$ Turn-On Delay Time	All			40*	ns	
t_r Rise Time	All			35*	ns	$V_{DD} = 175V, I_D \approx 1.25A$ $R_L = 25\Omega, R_{L\text{load}} = 140\Omega$
$t_{d(off)}$ Turn-Off Delay Time	All			60*	ns	(MOS FET switching times are essentially independent of operating temperature.)
t_f Fall Time	All			35*	ns	

THERMAL RESISTANCE

R_{thJC} Junction-to-Case ..	All			6.25*	$^\circ\text{C}/\text{W}$	
R_{thJA} Junction-to-Ambient	All			170	$^\circ\text{C}/\text{W}$	Free Air Operation

BODY-DRAIN DIODE RATINGS AND CHARACTERISTICS

I_S Continuous Source Current (Body Diode)	2N6791			-2*	A	Modified MOS POWER symbol showing the integral P-N junction rectifier. 
	2N6792			-2*	A	
I_{SM} Source Current ¹ (Body Diode)	2N6791			-4	A	
	2N6792			-4	A	
V_{SD} Diode Forward Voltage ¹	2N6791	-0.6*		-1.4*	V	$T_C = 25^\circ\text{C}, I_S = -2A, V_{GS} = 0$ $T_C = 25^\circ\text{C}, I_S = -2A, V_{GS} = 0$
	2N6792	-0.6*		-1.4*	V	
t_{rr} Reverse Recovery Time	All		400		ns	$T_J = 150^\circ\text{C}, I_F = I_S, dI_F/dt = 100 \text{ A}/\mu\text{s}$

¹ Pulse Test: Pulse Width < 300 μsec , Duty Cycle < 2%

* JEDEC Registered Values

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